

L Number	Hits	Search Text	DB	Time stamp
1	32762	substrate with "GaAs"	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/08/29 08:01
2	1	(substrate with "GaAs") and (cover\$3 enclos\$3 cap lid encapsul\$3) with plastic near body	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/08/29 08:02
3	214	(substrate with "GaAs") and (cover\$3 enclos\$3 cap lid encapsul\$3) with plastic	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/08/29 08:04
4	41	((substrate with "GaAs") and (cover\$3 enclos\$3 cap lid encapsul\$3) with plastic) and base with "CuW" or "Cu/Mo/Cu"	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/08/29 08:08
5	4	((substrate with "GaAs") and (cover\$3 enclos\$3 cap lid encapsul\$3) with plastic) and base with ("CuW" or "Cu/Mo/Cu")	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/08/29 08:06
6	41	((substrate with "GaAs") and (cover\$3 enclos\$3 cap lid encapsul\$3) with plastic) and base and "CuW" or "Cu/Mo/Cu"	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/08/29 08:13
7	5	((substrate with "GaAs") and (cover\$3 enclos\$3 cap lid encapsul\$3) with plastic) and base and ("CuW" or "Cu/Mo/Cu")	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/08/29 08:35
8	2	("5598034").PN.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/08/29 08:36
9	2	("5644169").PN.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/08/29 08:36
-	195411	(cover\$3 enclos\$3 cap lid encapsul\$3) with plastic	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/08/29 08:02
-	2396	(cover\$3 enclos\$3 cap lid encapsul\$3) with plastic near body	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/08/29 08:01
-	0	((cover\$3 enclos\$3 cap lid encapsul\$3) with ((plastic near body) near5 (one-piece one?piece one adj piece))) with electric\$4 near3 lead	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/08/28 08:01

	0	((cover\$3 enclos\$3 cap lid encapsul\$3) with ((plastic near body) near5 (one-piece one?piece one adj piece))) with conduct\$4 near3 lead	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/08/28 07:52
	82	((cover\$3 enclos\$3 cap lid encapsul\$3) with ((plastic near body) near5 (one-piece one?piece one adj piece)))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/08/28 07:55
	0	((cover\$3 enclos\$3 cap lid encapsul\$3) with ((plastic near body) near5 (one-piece one?piece one adj piece))) with lead	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/08/28 07:53
	12	((cover\$3 enclos\$3 cap lid encapsul\$3) with ((plastic near body) near5 (one-piece one?piece one adj piece))) and electrical\$3	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/08/28 08:44
	10	((cover\$3 enclos\$3 cap lid encapsul\$3) with plastic near body) with electric\$4 near3 lead	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/08/28 09:05
	2	("5952714").PN.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/08/28 08:45
	2	("5598034").PN.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/08/28 14:42
	2	("5097318").PN.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/08/28 14:42